

PHASE CONTROL THYRISTORS

■ Junction Size:	Square 155 mils
■ Wafer Size:	4"
■ V_{RRM} Class:	1200 V
■ Passivation Process:	Glassivated MESA
■ Reference IR Packaged Part:	16TTS Series

Major Ratings and Characteristics

Parameters	Units	Test Conditions
V_{TM} Maximum On-state Voltage	1.4 V	$T_J = 25^\circ\text{C}$, $I_T = 10\text{ A}$
V_{RRM} Reverse Breakdown Voltage	1200 V	$T_J = 25^\circ\text{C}$, $I_{RRM} = 100\ \mu\text{A}$ (1)
I_{GT} Max. Required DC Gate Current to Trigger	60 mA	$T_J = 25^\circ\text{C}$, anode supply = 6 V, resistive load
V_{GT} Max. Required DC Gate Voltage to Trigger	2 V	$T_J = 25^\circ\text{C}$, anode supply = 6 V, resistive load
I_H Holding Current Range	5 to 100 mA	Anode supply = 6 V, resistive load
I_L Maximum Latching Current	200 mA	Anode supply = 6 V, resistive load

(1) Nitrogen flow on die edge.

Mechanical Characteristics

Nominal Back Metal Composition, Thickness	Cr - Ni - Ag (1 KA - 4 KA - 6 KA)
Nominal Front Metal Composition, Thickness	100% Al, (20 μ m)
Chip Dimensions	155 x 155 mils (see drawing)
Wafer Diameter	100 mm, with std. <110> flat
Wafer Thickness	350 μ m \pm 10 μ m
Maximum Width of Sawing Line	130 μ m
Reject Ink Dot Size	0.25 mm diameter minimum
Ink Dot Location	See drawing
Recommended Storage Environment	Storage in original container, in dessicated nitrogen, with no contamination

IR155BG12DCB

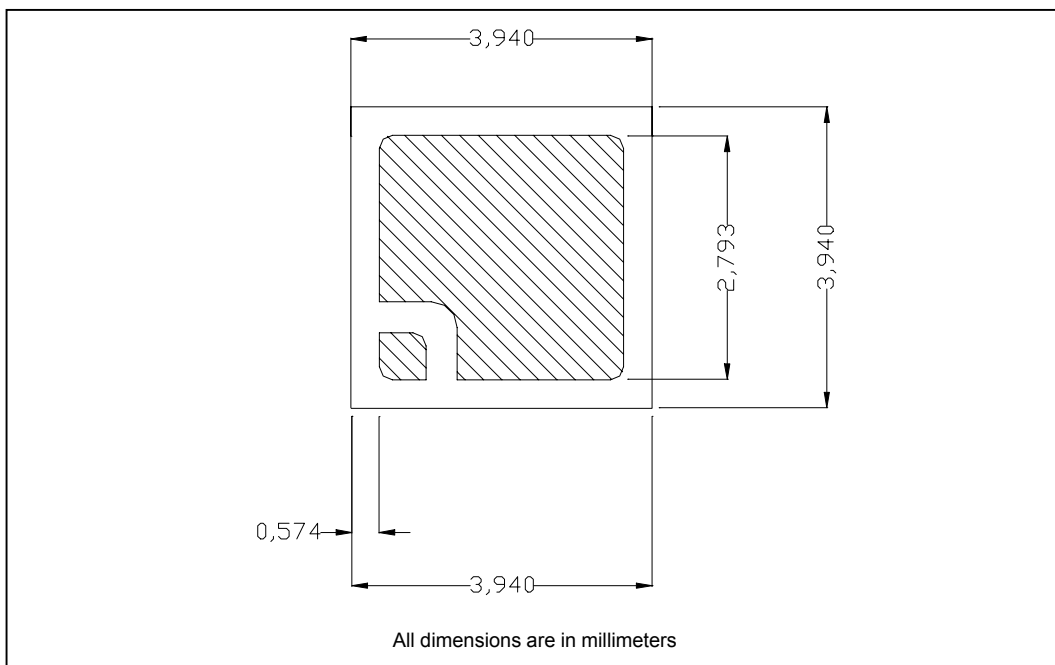
Bulletin 10213J 12/01

International
IR Rectifier

Ordering Information Table

Device Code						
IR	155	B	G	12	D	CB
①	②	③	④	⑤	⑥	⑦
1	- International Rectifier Device					
2	- Chip Dimension in Mils					
3	- Type of Device: B = Wire Bondable SCR					
4	- Passivation Process: G = Glassivated MESA					
5	- Voltage code: Code x 100 = V_{RRM}					
6	- Metallization: D = Silver (Anode) - Aluminium (Cathode)					
7	- CB = Probed Uncut Die (wafer in box) None = Probed Die in chip carrier					

Outline Table





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